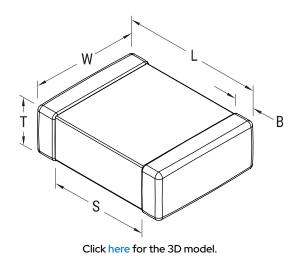


C1812X681KHRACTU

Aliases (C1812X681KHRAC7800) SMD Comm X7R HV Flex, Ceramic, 680 pF, 10%, 3,000 VDC, X7R, SMD, MLCC, FT-CAP, Temperature Stable, 1812, 2.3 mm



General Information	
Series	SMD Comm X7R HV Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Temperature Stable
Features	FT-CAP, Temperature Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	185 mg
Shelf Life	78 Weeks
MSL	1

Dimensions		Spe
Chip Size	1812	Cap
L	4.5mm +/-0.4mm	Mea
W	3.2mm +/-0.3mm	Tole
т	1.6mm +/-0.20mm	Volt
S	2.3mm MIN	Diele
В	0.7mm +/-0.35mm	Tem
		Tem

Packaging Specifications

Packaging T&R, 180	
Packaging Quantity 1000	

Specifications	
Capacitance	680 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	3000 VDC
Dielectric Withstanding Voltage	3,600 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5%1kHz1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

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